

<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> ( Not for submission under 37 CFR 1.99)	<b>Application Number</b>		10645047
	<b>Filing Date</b>		2003-06-21
	<b>First Named Inventor</b>	Sampath Purushothaman et al.	
	<b>Art Unit</b>	2822	
	<b>Examiner Name</b>	David E. Graybill	
<b>Attorney Docket Number</b>		YOR920030029US2 (16841)	

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**INFORMATION DISCLOSURE  
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Application Number	10645047
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	3	SHIH, D.-Y. ET AL., Cu Passivation: A Method of Inhibiting Copper-Polyamic Acid Interactions, Appl. Phys. Lett., September 16, 1991, pp. 1424-1426, Vol. 59, No. 12	<input type="checkbox"/>
	4	OHUCHI, F. S. ET AL., Summary Abstract: Ti as a Diffusion Barrier Between Cu and Polyimide, J. Vac. Sci. Technol. A, May/June 1988, pp. 1004-1006, Vol. 6, No. 3	<input type="checkbox"/>
	5	O'SULLIVAN, E. J. ET AL., Electrolessly Deposited Diffusion Barriers for Microelectronics, IBM J. Res. Develop., September 1998, pp. 607-620, Vol. 42, N. 5	<input type="checkbox"/>
	6	SRINIVASAN, R. ET AL., Ultraviolet Laser Ablation of Organic Polymers, Chem. Rev., 1989, pp. 1303-1316, Vol. 89	<input type="checkbox"/>
	7	KOWALCZYK, STEVEN P. ET AL., Polyimide on Copper: The Role of Solvent in the Formation of Copper Precipitates, Appl. Phys. Lett., February 1988, pp. 375-376, Vol. 52, No. 5	<input type="checkbox"/>
	8	KIM, Y.-H. ET AL., Adhesion and Interface Investigation of Polyimide on Metals, J. Adhesion Sci. Technol., 1998, pp. 95-105, Vol. 2, No. 2	<input type="checkbox"/>
	9	LEE, K.-W. ET AL., Adhesion of Poly(arylene ether benzimidazole) to Copper and Polyimides, J. Adhesion Sci. Technol., 1996, pp. 807-821, Vol. 10, No. 9	<input type="checkbox"/>

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10	MATIENZO, LUIS J. ET AL., Adhesion of Metal Films to Polyimides, IBM Corp., Endicott, NY	<input type="checkbox"/>
11	LINDE, H. G., Adhesive Interface Interactions Between Primary Aliphatic Amine Surface Conditioners and Polyamic Acid/Polyimide Resins, J. Poly. Sci.: Poly. Chem. Ed., 1982, pp. 1031-1041, Vol. 20	<input type="checkbox"/>

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- ☐ See attached certification statement.
- ☒ Fee set forth in 37 CFR 1.17 (p) has been submitted herewith.
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A signature of the applicant or representative is required in accordance with CFR 1.33, 10.18. Please see CFR 1.4(d) for the form of the signature.

Signature	/LESLIE S. SZIVOS/	Date (YYYY-MM-DD)	2007-01-11
Name/Print	Leslie S. Szivos	Registration Number	39,394

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